

DOCKET NO: 251393US2CONT

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :

TAKASHI YAMADA, ET AL. :

SERIAL NO: NEW CONT APPLICATION :

FILED: HERewith :

FOR: SEMICONDUCTOR CHIP HAVING :
MULTIPLE FUNCTIONAL BLOCKS
INTEGRATED IN A SINGLE CHIP
AND METHOD FOR
FABRICATING THE SAME

PRELIMINARY AMENDMENT

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

Prior to examination on the merits, please amend the above-identified application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 8 of this paper.